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LB11870

Monolithic Digital IC For Polygonal Mirror Motors Three-Phase Brushless Motor Driver

Overview

The LB11870 is a three-phase brushless motor driver developed for driving the motors used with the polygonal mirror in laser printers and plain paper copiers. It can implement, with a single IC chip, all the circuits required for polygonal mirror drive, including speed control and driver functions. The LB11870 can implement motor drive with minimal power loss due to its use of direct PWM drive.

Functions

- Three-phase bipolar drive
- Direct PWM drive
- Includes six high and low side diodes on chip.
- Output current control circuit
- PLL speed control circuit
- Phase lock detection output (with masking function)
- Includes current limiter, thermal protection, rotor constraint protection, and low-voltage protection circuits on chip.
- Deceleration type switching circuit (free running or reverse torque)
- PWM oscillator
- Power saving circuit

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Specifications

Absolute Maximum Ratings at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage	V_{CC} max		30	V
Output current	I_O max	$T \leq 500\text{ms}^*1$	2.3	A
Allowable power dissipation 1	P_d max1	Independent IC	0.85	W
Allowable power dissipation 2	P_d max2	Mounted on a circuit board *2	1.72	W
Operating temperature	T_{opr}		-20 to +80	$^\circ\text{C}$
Storage temperature	T_{stg}		-55 to +150	$^\circ\text{C}$

Note *1: Be sure to perform derating from the standard value by 20% or more before use.

Note *2: Mounted on a specified board: 114.3mm×76.1mm×1.6mm, glass epoxy

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Allowable Operating Ranges at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage range	V_{CC}		9.5 to 28	V
5V constant voltage output current	I _{REG}		0 to -20	mA
LD pin applied voltage	V _{LD}		0 to 28	V
LD pin output current	I _{LD}		0 to 15	mA
FGS pin applied voltage	V _{FG}		0 to 28	V
FGS pin output current	I _{FG}		0 to 10	mA

Electrical Characteristics at $T_a = 25^\circ\text{C}$, $V_{CC} = V_M = 24\text{V}$

Parameter	Symbol	Conditions	Ratings			unit
			min	typ	max	
Supply current 1	I_{CC1}			16	21	mA
Supply current 2	I_{CC2}	In stop mode		3.5	5.0	mA
[5V constant voltage output circuit]						
Output voltage	V _{REG}		4.65	5.0	5.35	V
Voltage regulation	ΔV_{REG1}	$V_{CC}=9.5$ to 28V		80	130	mV
Load regulation	ΔV_{REG2}	$I_O=-5$ to -20mA		10	60	mV
Temperature coefficient	ΔV_{REG3}	Design target value*		0		mV/ $^\circ\text{C}$
[Output Block]						
Output saturation voltage 1	V_O sat1	$I_O=0.5\text{A}$, $V_O(\text{SINK})+V_O(\text{SOURCE})$		1.9	2.4	V
Output saturation voltage 2	V_O sat2	$I_O=1.2\text{A}$, $V_O(\text{SINK})+V_O(\text{SOURCE})$		2.6	3.2	V
Output leakage current	I_O leak				100	μA
Lower diode forward voltage 1	VD1-1	$I_D=-0.5\text{A}$		1.0	1.3	V
Lower diode forward voltage 2	VD1-2	$I_D=-1.2\text{A}$		1.4	1.8	V
Upper diode forward voltage 1	VD2-1	$I_D=0.5\text{A}$		1.2	1.6	V
Upper diode forward voltage 2	VD2-2	$I_D=1.2\text{A}$		1.9	2.4	V
[Hall Amplifier Block]						
Input bias current	I _{HB}		-2	-0.5		μA
Common-mode input voltage range	V _{ICM}		0		V _{REG} -2.0	V
Hall input sensitivity			80			mV $\mu\text{p-p}$
Hysteresis width	$\Delta V_{IN}(\text{HA})$		15	24	42	mV
Input voltage: Low to high	V _{SLH}			12		mV
Input voltage: High to low	V _{SHL}			-12		mV
[FG Schmitt Block]						
Input bias current	I _B (FGS)		-2	-0.5		μA
Common-mode input voltage range	V _{ICM} (FGS)		0		V _{REG} -2.0	V
Input sensitivity	V_{IN} (FGS)		80			mV $\mu\text{p-p}$
Hysteresis width	ΔV_{IN} (FGS)		15	24	42	mV
Input voltage: Low to high	V _{SLH} (FGS)			12		mV
Input voltage: High to low	V _{SHL} (FGS)			-12		mV

*: These value are design guarantee values, and are not tested.

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Parameter	Symbol	Conditions	Ratings			unit
			min	typ	max	
[PWM Oscillator]						
High-level output voltage	$V_{OH}(PWM)$		2.65	2.95	3.25	V
Low-level output voltage	$V_{OL}(PWM)$		0.9	1.2	1.5	V
External capacitor charge current	ICHG	VPWM=2V	-60	-45	-30	μA
Oscillator frequency	f(PWM)	C=680pF		34		kHz
Amplitude	V(PWM)		1.45	1.75	2.05	Vp-p
[FGS Output]						
Output saturation voltage	$V_{OL}(FGS)$	IFGS=7mA		0.15	0.5	V
Output leakage current	IL(FGS)	$V_O=V_{CC}$			10	μA
[CSD Oscillator Circuit]						
High-level output voltage	$V_{OH}(CSD)$		3.2	3.5	3.8	V
Low-level output voltage	$V_{OL}(CSD)$		0.9	1.1	1.3	V
Amplitude	V(CSD)		2.15	2.4	2.65	Vp-p
External capacitor charge current	ICHG1		-13.5	-9.5	-5.5	μA
External capacitor charge current	ICHG2		6	10	14	μA
Oscillator frequency	f(CSD)	C=0.068 μF		29		Hz
[Phase Comparator Output]						
High-level output voltage	VPDH	$I_{OH}=-100\mu A$	VREG-0.2	VREG-0.1		V
Low-level output voltage	VPDL	$I_{OL}=100\mu A$		0.2	0.3	V
Output source current	IPD+	VPD=VREG/2			-0.5	mA
Output sink current	IPD-	VPD=VREG/2	1.5			mA
[Lock Detection Output]						
Output saturation voltage	$V_{OL}(LD)$	ILD=10mA		0.15	0.5	V
Output leakage current	IL(LD)	$V_O=V_{CC}$			10	μA
[Error Amplifier Block]						
Input offset voltage	$V_{IO}(ER)$	Design target value*	-10		10	mV
Input bias current	IB(ER)		-1		1	μA
Output H level voltage	$V_{OH}(ER)$	$I_{OH}=500\mu A$	VREG-1.2	VREG-0.9		V
Output L level current	$V_{OL}(ER)$	$I_{OL}=500\mu A$		0.9	1.2	V
DC bias level	VB(ER)		-5%	VREG/2	5%	V
[Current limiter Circuit]						
Drive gain 1	GDF1	When the phase is locked	0.4	0.5	0.6	deg
Drive gain 2	GDF2	When not locked	0.8	1.0	1.2	deg
Limiter voltage	VRF	$V_{CC}-V_M$	0.45	0.5	0.55	V
[Thermal Shutdown Operation]						
Thermal shutdown operating temperature	TSD	Design target value* (junction temperature)	150	175		$^{\circ}C$
Hysteresis width	ΔTSD	Design target value* (junction temperature)		40		$^{\circ}C$
[Low-Voltage Protection]						
Operating voltage	VSD		8.1	8.45	8.9	V
Hysteresis width	ΔVSD		0.2	0.35	0.5	V

*: These value are design guarantee values, and are not tested.

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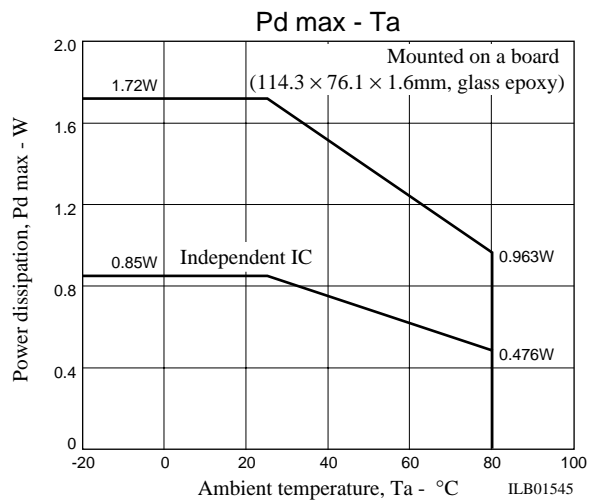
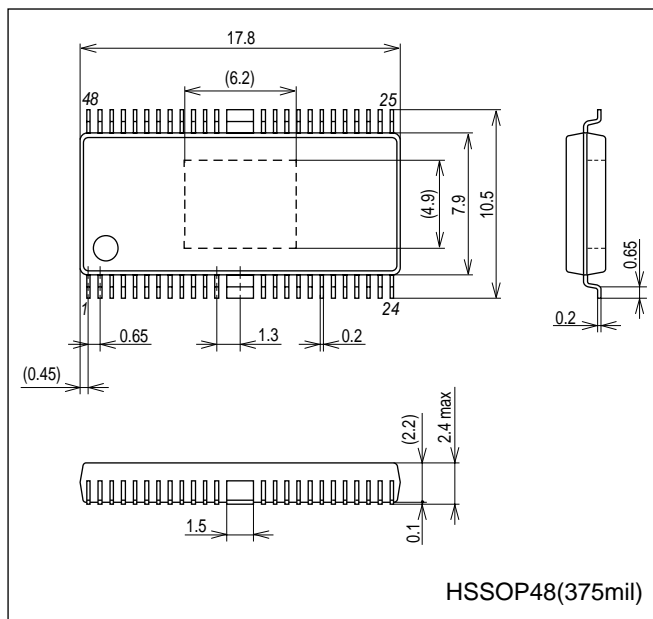
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Parameter	Symbol	Conditions	Ratings			unit
			min	typ	max	
[CLD Circuit]						
External capacitor charge current	ICLD		-6	-4.3	-3	μA
Operating voltage	$V_H(\text{CLD})$		3.25	3.5	3.75	V
[CLK Pin]						
External input frequency	fI(CLK)		0.1		10	kHz
High-level input voltage	$V_{IH}(\text{CLK})$		3.5		VREG	V
Low-level input voltage	$V_{IL}(\text{CLK})$		0		1.5	V
Input open voltage	$V_{IO}(\text{CLK})$		VREG-0.5		VREG	V
Hysteresis width	$V_{IS}(\text{CLK})$		0.35	0.5	0.65	V
High-level input current	$I_{IH}(\text{CLK})$	VCLK=VREG	-10	0	10	μA
Low-level input current	$I_{IL}(\text{CLK})$	VCLK=0V	-280	-210		μA
[S/S Pin]						
High-level input voltage	$V_{IH}(\text{SS})$		3.5		VREG	V
Low-level input voltage	$V_{IL}(\text{SS})$		0		1.5	V
Input open voltage	$V_{IO}(\text{SS})$		VREG-0.5		VREG	V
Hysteresis width	$V_{IS}(\text{SS})$		0.35	0.5	0.65	V
High-level input current	$I_{IH}(\text{SS})$	VS/S=VREG	-10	0	10	μA
Low-level input current	$I_{IL}(\text{SS})$	VS/S=0V	-280	-210		μA
[BRSEL Pin]						
High-level input voltage	$V_{IH}(\text{BRSEL})$		3.5		VREG	V
Low-level input voltage	$V_{IL}(\text{BRSEL})$		0		1.5	V
Input open voltage	$V_{IO}(\text{BRSEL})$		VREG-0.5		VREG	V
High-level input current	$I_{IH}(\text{BRSEL})$	$V_{BRSEL}=\text{VREG}$	-10	0	10	μA
Low-level input current	$I_{IL}(\text{BRSEL})$	$V_{BRSEL}=0\text{V}$	-220	-160		μA

Package Dimensions

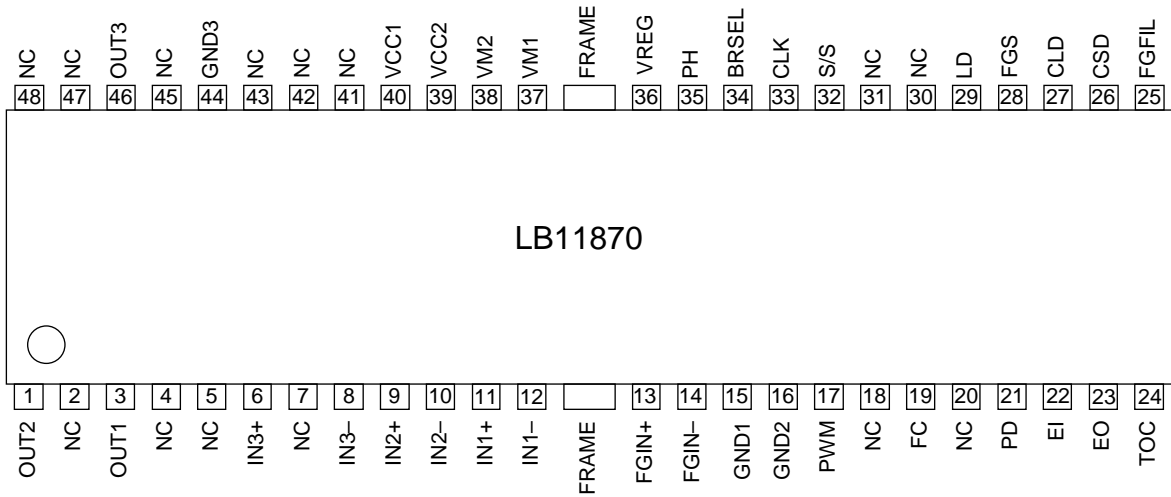
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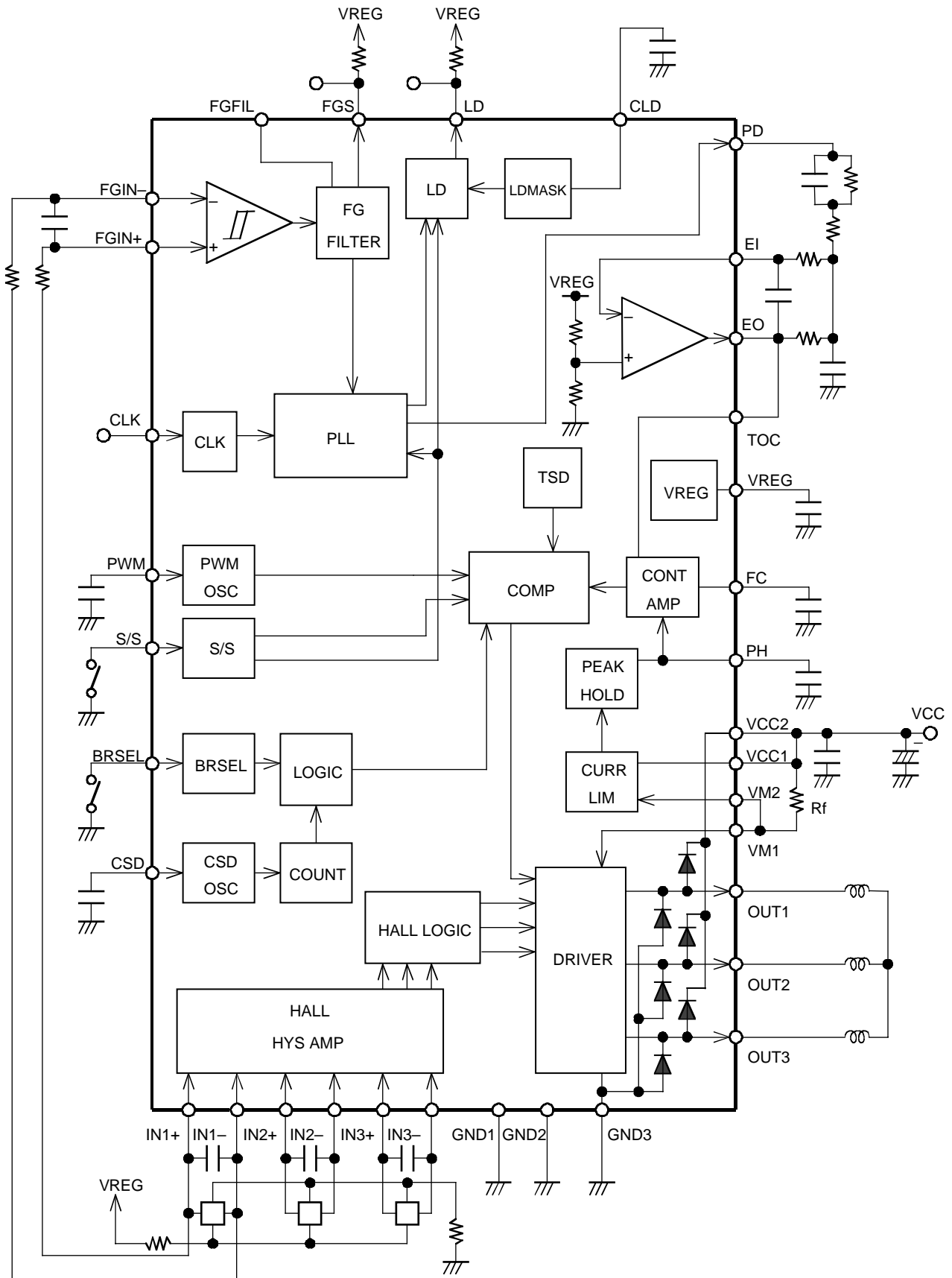
Pin Assignment



Three-Phase Logic Truth Table (IN = [H] indicates a condition in which: IN+ > IN-)

IN1	IN2	IN3	OUT1	OUT2	OUT3
H	L	H	L	H	M
H	L	L	L	M	H
H	H	L	M	L	H
L	H	L	H	L	M
L	H	H	H	M	L
L	L	H	M	H	L

Block Diagram and Application Circuit Example



Pin Functions

Pin No.	Symbol	Pin Description	Equivalent Circuit
3 1 46	OUT1 OUT2 OUT3	Motor drive output	
44	GND3	Output block ground	
37 38	VM1 VM2	Output block power supply and current detection. Insert the resistor R_f between this pin and V_{CC1} . The output current will be limited to the current value $I_{OUT} = V_{RF}/R_f$.	
39	V_{CC2}	Upper diode cathode connection. Short this pin to V_{CC1} .	
11 12 9 10 6 8	IN1+ IN1- IN2+ IN2- IN3+ IN3-	Hall element inputs. The high state is when IN+ is greater than IN-, and the low state is the reverse. An amplitude of at least 100mVp-p (differential) is desirable for the Hall element signal inputs. If noise on the Hall signals is a problem, insert capacitors between the IN+ and IN- inputs.	
13 14	FG _{IN+} FG _{IN-}	FG input. If noise on the FG signal input is a problem, connect a filter consisting of either a capacitor or a capacitor and a resistor.	
15	GND1	Control circuit block ground	
16	GND2	SUBGND pin	
17	PWM	Sets the PWM oscillator frequency. Insert a capacitor between this pin and ground. The PWM oscillator frequency is set to about 34kHz when a 680pF capacitor is used.	

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Pin No.	Symbol	Pin Description	Equivalent Circuit
19	FC	Frequency characteristics correction for the current control circuit. Insert a capacitor (about 0.01 to 0.1 μ F) between this pin and ground. The output duty is determined by comparing the voltage on this pin to the PWM oscillator waveform.	
21	PD	Phase comparator output. The phase error is converted to a pulse duty and output from this pin.	
22	EI	Error amplifier input.	
23	EO	Error amplifier output.	
24	TOC	Torque command voltage input. This pin is normally connected to the EO pin. When the TOC voltage falls, the lower output transistor on duty is increased.	

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Pin No.	Symbol	Pin Description	Equivalent Circuit
25	FGFIL	FG filter connection. If noise on the FG signal input is a problem, insert a capacitor (up to about 2200pF) between this pin and ground.	
26	CSD	Sets the rotor constraint protection circuit operating time and the initial reset pulse. A protection operating time of about 8 seconds can be set by insert a capacitor of about 0.068μF between this pin and ground. If the rotor constraint protection circuit is not used, insert a resistor and a capacitor in parallel between this pin and ground. (Values: about 220kΩ and 4700pF)	
27	CLD	Sets the phase lock state signal mask time. A mask time of about 90ms can be set by inserting a capacitor of about 0.1μF between this pin and ground. Leave this pin open if masking is not required.	
28	FGS	FG Schmitt output.	
29	LD	Phase lock state detection output. This output goes to the on state (low level) when the phase is locked.	

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Pin No.	Symbol	Pin Description	Equivalent Circuit
32	S/S	Start/stop control input. Low: 0 to 1.5V High: 3.5V to VREG Hysteresis: 0.5V Low: start. This pin goes to the high level when open.	
33	CLK	Clock input. Low: 0 to 1.5V High: 3.5V to VREG Hysteresis: 0.5V $f_{CLK} = 10\text{kHz}$ (maximum) If noise is a problem, use a capacitor to remove that noise at this input.	
34	BRSEL	Deceleration switching control input. Low: 0 to 1.5V High: 3.5V to VREG This pin goes to the high level when open. Low: reverse torque control, High: free running. An external Schottky barrier diode is required on the output low side if reverse torque control is used.	
35	PH	RF waveform smoothing. If noise on the RF waveform is a problem, insert a capacitor between this pin and ground.	

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Pin No.	Symbol	Pin Description	Equivalent Circuit
36	VREG	Stabilized power supply output (5V output). Insert a capacitor of about 0.1μF between this pin and ground for stabilization.	
40	V _{CC1}	Power supply. Insert a capacitor of at least 10μF between this pin and ground to prevent noise from entering the IC.	
2, 4, 5 7, 18 20, 30 31, 41 42, 43 45, 47 48	NC	Since these pins are not connected to the IC internally, they can be used for wiring connections.	
	FRAME	Connect this pin to ground.	

Overview of the LB11870

1. Speed Control Circuit

This IC adopts a PLL speed control technique and provides stable motor operation with high precision and low jitter. This PLL circuit compares the phase error at the edges of the CLK signal (falling edges) and FG signal (falling edges on the FGIN+ and FGS signals), and the IC uses the detected error to control motor speed. During this control operation, the FG servo frequency will be the same as the CLK frequency.

$$f_{FG} (\text{servo}) = f_{CLK}$$

2. Output Drive Circuit

To minimize power loss in the output circuits, this IC adopts a direct PWM drive technique. The output transistors are always saturated when on, and the IC adjusts the motor drive output by changing the output on duty. The low side output transistor is used for the output PWM switching.

Both the high and low side output diodes are integrated in the IC. However, if reverse torque control mode is selected for use during deceleration, or if a large output current is used and problems occur (such as incorrect operation or waveform disruption due to low side kickback), a Schottky diode should be inserted between OUT and ground. Also, if it is necessary to reduce IC heating during steady-state (constant speed) operation, it may be effective to insert a Schottky diode between V_{CC} and OUT. (This is effective because the load associated with the regenerative current during PWM switching is born not by the on-chip diode but by the external diode.)

3. Current Limiter Circuit

The current limiter circuit limits the peak level of the current to a level determined by $I = V_{RF}/R_f$ (where $V_{RF} = 0.5V$ (typical) and R_f is the value of the current detection resistor). The current limiter operates by reducing the output on duty to suppress the current.

The current limiter circuit detects the reverse recovery current of the diode due to PWM operation. To assure that the current limiting function does not malfunction, its operation has a delay of about 2μs. If the motor coils have a low resistance or a low inductance, current fluctuations at startup (when there is no reactive power in the motor) will be rapid. The delay in this circuit means that at such times the current limiter circuit may operate at a point well above the set current. Designers must take this increase in the current due to the delay into account when setting the current limiter value.

4. Power Saving Circuit

This IC goes into a power saving state that reduces the current drain in the stop state. The power saving state is implemented by removing the bias current from most of the circuits in the IC. However, the 5V regulator output is provided in the power saving state.

5. Reference Clock

Care must be taken to assure that no chattering or other noise is present on the externally input clock signal. Although the input circuit does have hysteresis, if problems do occur, the noise must be excluded with a capacitor. If the IC is set to the start state when the reference clock signal is not present, if the rotor constraint protection circuit is used, the motor will turn somewhat and then motor drive will be shut off. However, if the rotor constraint protection circuit is not used, and furthermore reverse torque control mode is selected for deceleration, the motor will be driven at ever increasing speed in the reverse direction. (This is because the rotor constraint protection circuit oscillator signal is used for clock cutoff protection.) Applications must implement a workaround for this problem if there is any possibility whatsoever for it to occur.

6. Notes on the PWM Frequency

The PWM frequency is determined by the value of the capacitor C (in F) connected to the PWM pin.

$$f_{\text{PWM}} \approx 1 / (43000 \times C)$$

If a 680pF capacitor is used, the circuit will oscillate at about 34kHz. If the PWM frequency is too low, the motor will emit switching noise, and if it is too high, the power loss in the output will be excessive. A PWM frequency in the range 15 to 50kHz is desirable. To minimize the influence of the output on this circuit, the ground lead of this capacitor should be connected as close as possible to the IC control system ground (the GND1 pin).

7. Hall Input Signals

Signals with an amplitude in excess of the hysteresis (42mV maximum) must be provided as the Hall input signals. However, an amplitude of over 100mV is desirable to minimize the influence of noise. If the output waveforms are disturbed (at phase switching) due to noise on the Hall inputs, insert capacitors across these inputs.

8. FG Input Signal

Normally, one phase of the Hall signals is input as the FG signal. If noise is a problem the input must be filtered with either a capacitor or an RC filter circuit. Although it is also possible to remove FG signal noise by inserting a capacitor between the FGFIL pin and ground, the IC may not be able to operate correctly if this signal is damped excessively. If this capacitor is used, its value must be less than about 2200pF. If the location of this capacitor's ground lead is inappropriate, it may, inversely, make noise problems even more likely to occur. Thus the ground lead location must be chosen carefully.

9. Rotor Constraint Protection Circuit

This IC provides a rotor constraint protection circuit to protect the IC itself and the motor when the motor is constrained. If the LD output is high (unlocked) for over a certain fixed period with the IC in the start state, the low side transistor will be turned off. The time constant is determined by the capacitor connected to the CSD pin.

$$\langle \text{time constant (in seconds)} \rangle \approx 120 \times C (\mu\text{F})$$

If a 0.068μF capacitor is used, the protection time will be about 8 seconds. The set time must be selected to have an adequate margin with respect to the motor startup time. This protection circuit will not operate during deceleration when the clock frequency is switched. To clear the rotor constraint protection state, the IC must be set to the stopped state or the power must be turned off and reapplied.

Since the CSD pin also functions as the initial reset pulse generation pin at startup, the logic circuit will go to the reset state and the IC will not be able to function if this pin is connected to ground. Therefore, both a 220kΩ resistor and a 4700pF capacitor must be inserted between this pin and ground if the rotor constraint protection circuit is not used.

10. Phase Lock Signal

(1) Phase lock range

Since this IC does not include a counter or similar functionality in the speed control system, the speed error range in the phase locked state cannot be determined solely by IC characteristics. (This is because the acceleration of the changes in the FG frequency influences the range.) When it is necessary to stipulate this characteristic for the motor, the designer must determine this by measuring the actual motor state. Since speed errors occur easily in states where the FG acceleration is large, it is thought that the speed errors will be the largest during lock pull-in at startup and when unlocked due to switching clock frequencies.

(2) Masking function for the phase lock state signal

A stable lock signal can be provided by masking the short-term low-level signals due to hunting during lock pullin. However, this results in the lock state signal output being delayed by the masking time.

The masking time is determined by the capacitor inserted between the CLD pin and ground.

$$\langle \text{masking time (seconds)} \rangle \approx 0.9 \times C (\mu\text{F})$$

When a 0.1 μ F capacitor is used, the masking time will be about 90ms. In cases where complete masking is required, a masking time with fully adequate margin must be used. If no masking is required, leave the CLD pin open.

11. Power Supply Stabilization

Since this IC provides a large output current and adopts a switching drive technique, the power supply line level can be disrupted easily. Thus capacitors large enough to stabilize the power supply voltage must be inserted between the VCC pins and ground. The ground leads of these capacitors must be connected to the three pins that are the power grounds, and they must be connected as close as possible to the pins themselves. If these capacitors (electrolytic capacitors) cannot be connected close to their corresponding pins, ceramic capacitors of about 0.1 μ F must be connected near these pins.

If reverse torque control mode is selected for use during deceleration, since there are states where power is returned to the power supply system, the power supply line levels will be particularly easily disrupted. Since the power line level is most easily disrupted during lock pull-in at high motor speeds, this state needs extra attention; in particular, capacitors that are adequately large to handle this situation must be selected.

If diodes are inserted in the power supply lines to prevent destruction of the device if the power supply is connected with reverse polarity, the power supply line levels will be even more easily disrupted, and even larger capacitors must be used.

12. VREG Stabilization

A capacitor of at least 0.1 μ F must be used to stabilize the VREG voltage, which is the control circuit power supply. The ground lead of that capacitor must be connected as close as possible to the IC control system ground (GND1).

13. Error Amplifier External Component Values

To prevent adverse influence from noise, the error amplifier external components must be located as close to the IC as possible. In particular, they must be located as far from the motor as possible.

14. FRAME Pin and the IC Metallic Rear Surface

The FRAME pin must be connected to the GND1 and GND2 pins, and the ground side of the electrolytic capacitor must be connected to GND3. The IC's metallic rear surface is connected to the FRAME pin internally to the IC. Thermal dissipation can be improved significantly by tightly bonding the metallic surface of the back of the IC package to the PCB with, for example, a solder with good thermal conductivity.

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